2023 IEEE International Conference on Applied Superconductivity

and Electromagnetic Devices (ASEMD2023)

27-29 October 2023, Tianjin, China

2023 IEEE International Conference on Applied Superconductivity and Electromagnetic Devices (ASEMD2023) will be held from 27th to 29th October 2023 in Tianjin, China.

ASEMD2023 is the 7th in its series of the International Conference on Applied Superconductivity and Electromagnetic Devices. It provides a professional platform for both academics and researchers from university and research institutes, and experts from industry in the relevant fields to share ideas focusing on Applied Superconductivity and Electromagnetic Devices, present research, display products, and discuss past experiences and future developments. The conference is principally sponsored by IEEE, Tianjin University, and will be organized by Tianjin University with supports from a number of universities, institutions and industrial partners.

Scope of the conference includes principally the following topics: Large Scale Applied Superconductivity (high current, high field, high power) Superconducting Electronics Superconducting and Electromagnetic Materials Electromagnetic Devices Electric Power Devices Electrical Machines High Efficiency Power Devices Electronic Devices and Circuits Control and Measurement Computation and Informatics Quantum computing, Tera-hertz, etc.

To submit your papers, please contact asemdinquiry@163.com. Authors are required to register, and present their papers at the conference. The conference full papers will be reviewed for the inclusion of the IEEE Transactions on Applied Superconductivity ASEMD2023 Special Issue to be published in 2024.

Important dates: Now - Open of 2-page conference paper submission 31/7/2023 - Deadline for 2-page conference paper submission 1/8/2023 - Early bird conference registration deadline 27-29/10/2023 - Conference date 1/11/2023 - Open of TAS full paper submission system Brief History of **ASEMD Publications**:

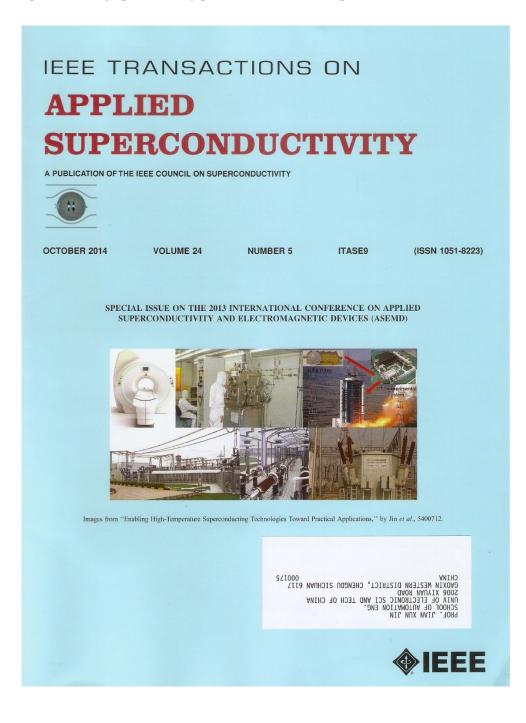
IEEE TASC - ASEMD Special Issues from ASEMD2013 to ASEMD2020

IEEE Transactions on Applied Superconductivity, vol. 31, no. 8, Nov. 2021. https://ieeexplore.ieee.org/xpl/tocresult.jsp?isnumber=9489267&punumber=77

IEEE Transactions on Applied Superconductivity, vol. 29, no. 2, Mar. 2019. https://ieeexplore.ieee.org/xpl/tocresult.jsp?isnumber=8573909&punumber=77

IEEE Transactions on Applied Superconductivity, vol. 26, no. 7, Oct. 2016. https://ieeexplore.ieee.org/xpl/tocresult.jsp?isnumber=7490330&punumber=77

IEEE Transactions on Applied Superconductivity, vol. 24, no. 5, Oct. 2014. https://ieeexplore.ieee.org/xpl/tocresult.jsp?isnumber=6849037&punumber=77



https://attend.ieee.org/asemd-2023/

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HOME	COMMITTEE	PROGRAM	FOR AUTHORS	VENUE	FOR REVIEWERS	SPONSORS	CONTACT ORGANIZER

Important Date Conference date: 27-29/10/2023 Deadline for paper submission: 31/07/2023 Early bird registration deadline: 01/08/2023

IEEE 2023 International Conference on Applied Superconductivity and Electromagnetic Devices

(ASEMD2023)

Sponsored by IEEE Beijing Section and hosted by Tianjin University, ASEMD2023 will be held in Tianjin, China, from October 27 to 29, 2023.

The conference will focus on the topics of applied superconductivity, electromagnetic devices and power systems. It aims to provide a platform for research scholars, technicians and related personnel engaged in high-temperature superconductivity and other related topics to share scientific research results and cutting-edge technologies, understands academic development trends, broaden research ideas, strengthen academic research and discussion, and promote industrial cooperation of academic results.

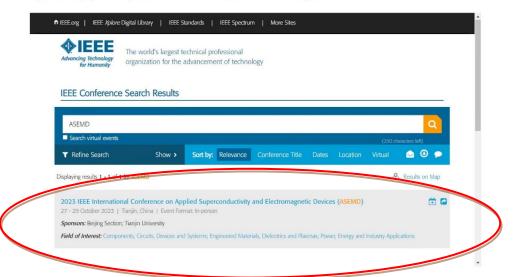
The conference sincerely invites experts, scholars, business people and other relevant personnel from universities and scientific research institutions at home and abroad to participate in the exchange.

All the conference submissions are required to be presented in the conference. In order to ensure that all authors can participate in the conference, this conference also sets up an online meeting venue for individuals who have difficulty to reach the physical conference venue. Online participation needs special application.

ASEMD2023 registered participants will receive the conference author kit package by emails to proceed. Login code is required to attend the online virtual ASEMD2023 conference. The online conference procedure and operation details will be posted and the authors will be informed by emails.



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IEEE Registration and IEEE System Information





SUN, SEP 1, 2024 - FRI, SEP 6, 2024
Applied Superconductivity Conference 2024

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